

FDP6N60ZU / FDPF6N60ZUT N-Channel MOSFET, FRFET 600V, 4.5A, 2Ω

Features

- $R_{DS(on)} = 1.7\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 2.25A$
- Low gate charge (Typ. 14.5nC)
- Low C_{rss} (Typ. 5pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

GDS

RoHS compliant

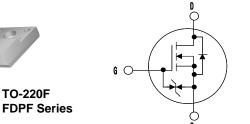


GDS

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

TO-220

FDP Series

Symbol	Parameter			FDP6N60ZU	FDPF6N60ZUT	Units	
V _{DSS}	Drain to Source Voltage			600		V	
V _{GSS}	Gate to Source Voltage			±30		V	
ID	Drain Current	-Continuous ($T_c = 25^{\circ}C$)		4.5	4.5*	٨	
		-Continuous ($T_C = 100^{\circ}C$)		2.7	2.7*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	18*	А	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	150		mJ	
I _{AR}	Avalanche Current		(Note 1)	4.5		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	10.5		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		105	33.8	W	
		- Derate above 25°C		0.85	0.27	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperatu 1/8" from Case for 5 Secor		3	00	°C		

Thermal Characteristics

Symbol	Parameter	FDP6N60ZU	FDPF6N60ZUT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	3.7	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ.		-	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

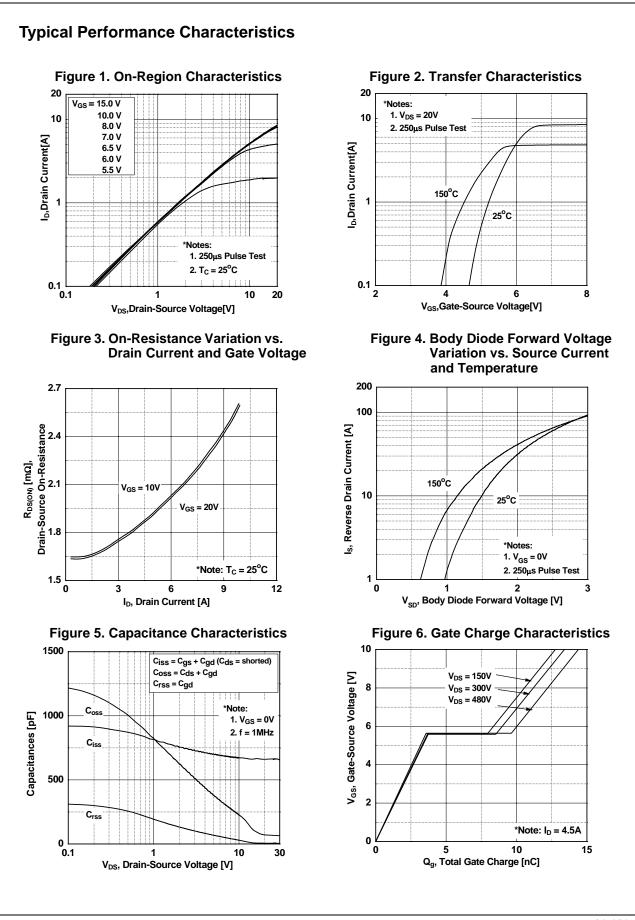
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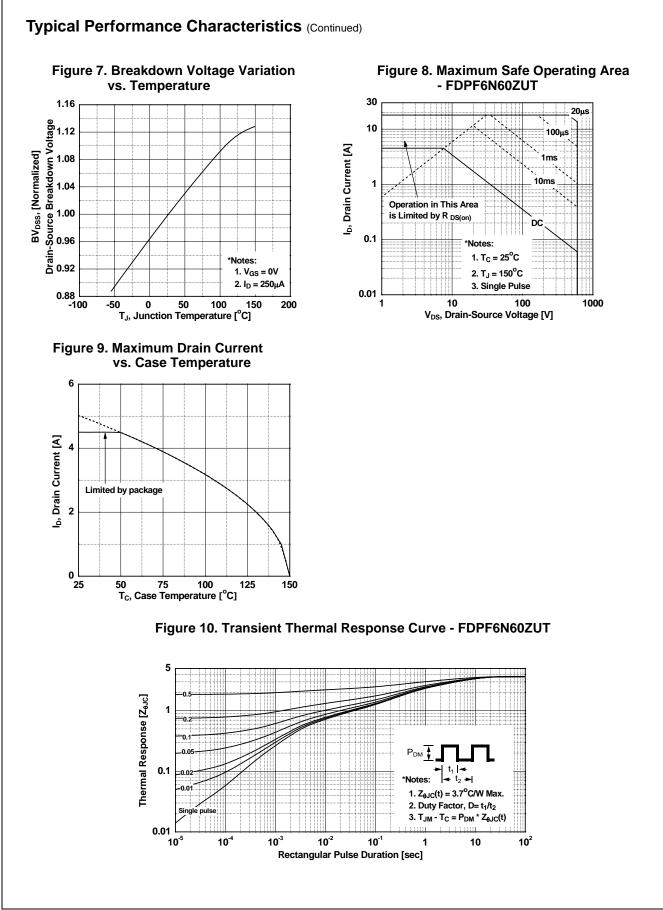
UniFET[™]

FDP6N60ZU FDP6N60ZU TO-2		Packa	kage Reel Size Tape		e Width		Quantit	y		
		TO-22	20	-		-		50 50		
		TO-22	0F	-		-				
Electrica	l Char	actoristics T	25°C uplose	othonwi	so noted			1		
Symbol	al Characteristics T _C = 25°C unless Parameter			Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	teristic	S								
BV _{DSS}	Drain to	o Source Breakdown V	oltage	$I_D = 250 \mu A, V_{GS} = 0V, T_J = 25^{\circ}C$		600	-	-	V	
ΔBV_{DSS} $\Delta T_{,l}$	Breakdown Voltage Temperature Coefficient		$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	0.75	-	V/°C		
	7	ata Maltana Duain Cumu		V _{DS} =	600V, V _{GS} = 0V		-	-	25	μA
DSS	zero G	ate Voltage Drain Curre	11		480V, T _C = 125 ^o C		-	-	250	
I _{GSS}	Gate to	Body Leakage Curren	t		±30V, V _{DS} = 0V		-	-	±10	μA
On Charac	teristic	S				ļ			·	•
V _{GS(th)}		Gate Threshold Voltage		V _{CS} =	V _{GS} = V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		ain to Source On Resistance		$V_{GS} = 10V, I_D = 2.25A$		-	1.7	2.0	Ω	
9FS	Forwar	rward Transconductance		$V_{\rm DS} = 40V, I_{\rm D} = 2.25A$			-	3.5	-	S
C _{iss} C _{oss}	Output	but Capacitance		- V _{DS} = f = 1N	: 25V, V _{GS} = 0V 1Hz	-	-	650 75	865 100	pF pF
C _{rss}		Reverse Transfer Capacitance					-	5	10	pF
Qg		otal Gate Charge at 10V				-	14.5	20	nC	
Q _{gs}	Gate to Source Gate Charge		$V_{DS} = 480V, I_D = 4.5A$ $V_{GS} = 10V$		-	-	4	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4)		-	6	-	nC	
Switching	Charac	teristics								
t _{d(on)}	Turn-O	n Delay Time	e				-	19	48	ns
t _r	Turn-Or	n Rise Time		$V_{DD} = 300V, I_D = 4.5A$			-	25	60	ns
t _{d(off)}	Turn-Of	ff Delay Time		$R_{G} = 2$	$R_{G} = 25\Omega, V_{GS} = 10V$		-	25	60	ns
t _f	Turn-Off Fall Time		(Note 4)		-	45	100	ns		
^t d(on) t _r t _{d(off)} t _f	Turn-Or Turn-Of	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time		$R_{G} = 25\Omega, V_{GS} = 10V$		-	25 25	60 60	1	
Drain-Sou	rce Dio	de Characteristic	S							
I _S	Maximum Continuous Drain to Source Diod			de Forwa	ard Current		-	-	4.5	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Fo		orward Current			-	-	18	Α	
V _{SD}	Drain to	Source Diode Forward	d Voltage	V _{GS} =	V _{GS} = 0V, I _{SD} = 4.5A		-	-	1.6	V
t _{rr}	Reverse	e Recovery Time			0V, I _{SD} = 4.5A		-	36	-	ns
Q _{rr}	-	everse Recovery Charge		$dI_{\rm F}/dt = 100A/\mu s$		-	37	-	nC	

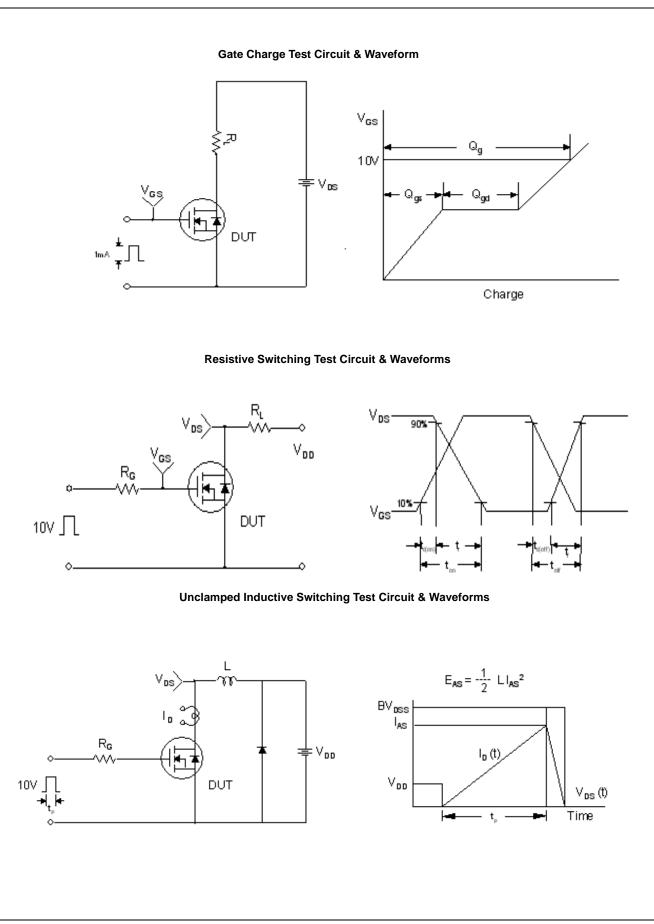
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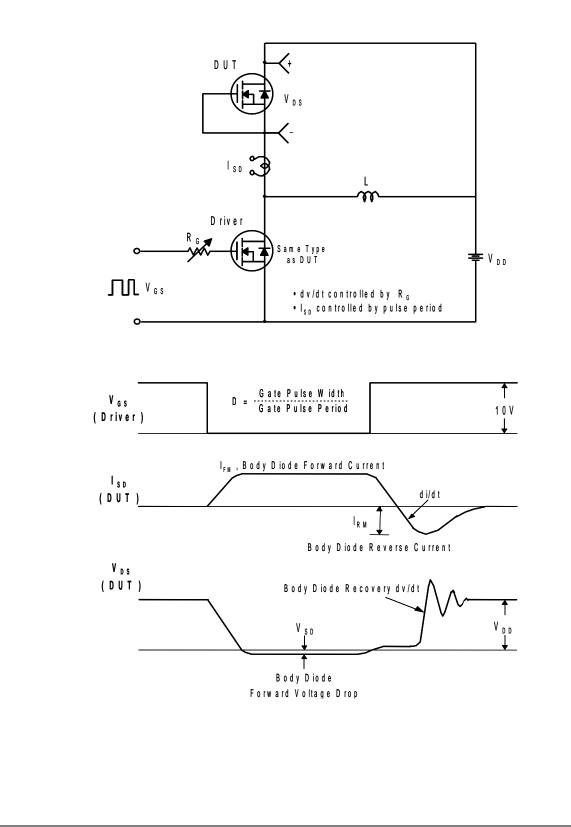


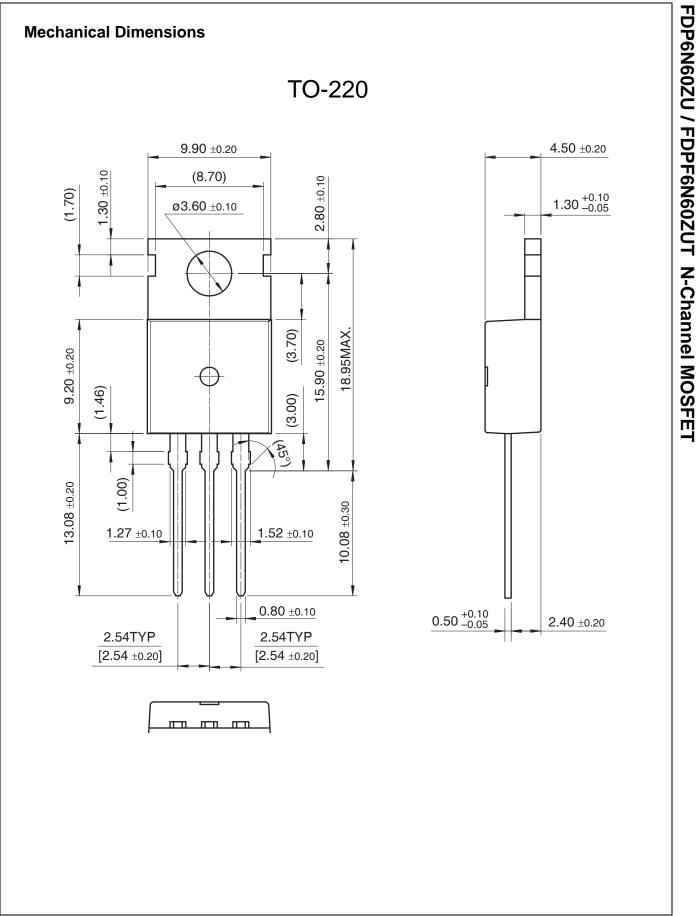


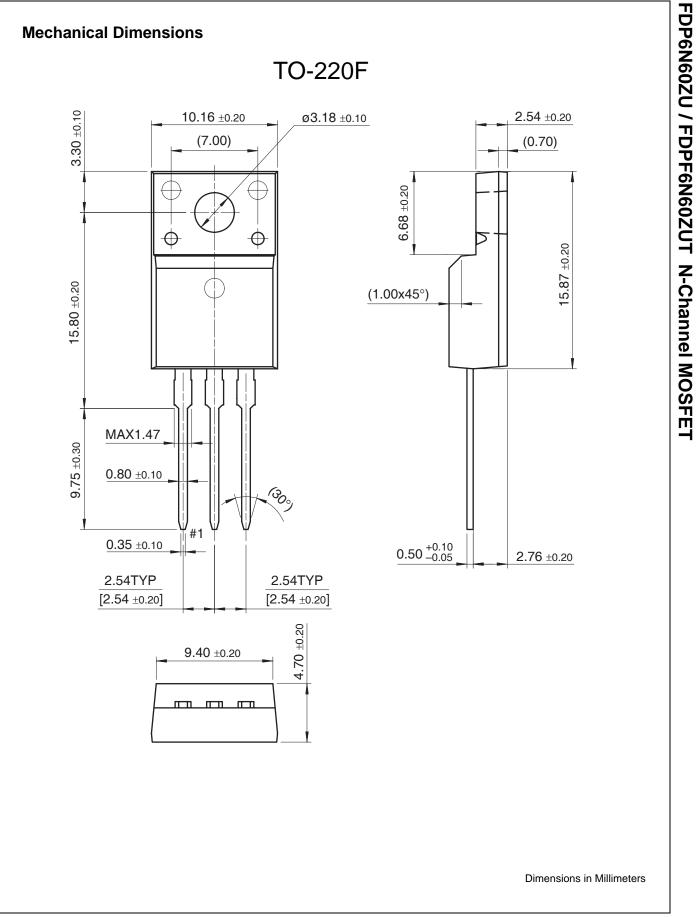
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Peak Diode Recovery dv/dt Test Circuit & Waveforms









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